

R6015ANX

Nch 600V 15A Power MOSFET

Datasheet

V _{DSS}	600V
R _{DS(on)} (Max.)	0.3Ω
I _D	±15A
PD	77W

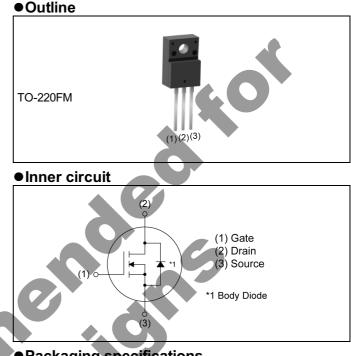
Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V_{GSS}) guaranteed to be ±30V.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.

Switching Power Supply

Application

6) Pb-free lead plating ; RoHS compliant



Packaging specifications

Packing	Bulk
Reel size (mm)	-
Tape width (mm)	-
Basic ordering unit (pcs)	500
Taping code	-
Marking	R6015ANX
	Reel size (mm) Tape width (mm) Basic ordering unit (pcs) Taping code

• Absolute maximum ratings (T_a = 25°C , unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	600	V
Continuous duois ourrent	T _C = 25°C	۱ _D *1	±15	А
Continuous drain current	T _C = 100°C	I _D ^{*1}	±7.0	А
Pulsed drain current		I _{DP} *2	±60	А
Gate - Source voltage		V _{GSS}	±30	V
Avalanche current, single pulse	I _{AS} *3	7.5	А	
Avalanche energy, single pulse	E _{AS} *3	E _{AS} *3	15	mJ
Avalanche energy, repetitive		E _{AR} *4	3.5	mJ
Power dissipation $(T_c = 25^{\circ}C)$		P _D	77	W
Junction temperature	Tj	150	°C	
Operating junction and storage tem	T _{stg}	-55 to +150	°C	
Reverse diode dv/dt		dv/dt	15	V/ns

Zero gate voltage

Gate - Source leakage current

Gate threshold voltage

Static drain - source

on - state resistance

Gate resistance

drain current

• Absolute maximum ratings

Baramatar		S	umbol	0	ondition	-	Values	Llpit
Parameter		5	ymbol	C	onation	S	values	Unit
Drain Source voltage clane			dv/dt		180V, I _D	= 15A	50	V/ns
Drain - Source voltage slope			uv/ut	T _j = 125	5°C		50	V/115
●Thermal resistance								
Dement			0			Values	\mathbf{O}	1.1:4
Paramet	er		Syn	nbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - o	case	se R _{thJC}		hJC	- (-	1.62	°C/W
Thermal resistance, junction - a	ambient		R _t	hJA		-	70	°C/W
Soldering temperature, waveso	oldering for 10s		Ts	old		-	265	°C
•Electrical characteristics (T _a = 25°C)		Ø			9		
Parameter	Symbol		Condition			Values		Unit
Farameter	Symbol				Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS} V _{GS}	₆ = 0'	V, I _D = 1r	mA	600	-	-	V
Drain - Source avalanche breakdown voltage	V _{(BR)DS} V _{GS}	₆ = 0'	V, I _D = 15	5A	-	700	-	V
	VDS	5 = 6	00V, V _{GS}	= 0V				

 $T_i = 25^{\circ}C$

 $T_{i} = 125^{\circ}C$

 $T_i = 25^{\circ}C$

 $T_{i} = 125^{\circ}C$

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 V_{GS} = ±30V, V_{DS} = 0V

 V_{DS} = 10V, I_{D} = 1mA

V_{GS} = 10V, I_D = 7.5A

f = 1MHz, open drain

IDSS

 I_{GSS}

V_{GS(th)}

 ${\sf R}_{\sf DS(on)}{}^{*6}$

 R_{G}

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100

1000

±100

4.5

0.3

-

-

0.1

_

_

_

0.23

0.46

10.5

_

_

-

2.5

_

-

_

μA

nA

V

Ω

Ω

•Electrical characteristics (T_a = 25°C)

Deremeter	Sumbol	Conditiono		Values		Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transfer Admittance	Y _{fs} ^{∗6}	V _{DS} = 10V, I _D = 7.5A	4.5	11	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	1700		
Output capacitance	C _{oss}	V _{DS} = 25V	-	1120		pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	80	-	
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V,		64.7	-	
Effective output capacitance, time related	C _{o(tr)}	V _{DS} = 0V to 480V	9	204	-	pF
Turn - on delay time	t _{d(on)} *6	V _{DD} ~ 300V, V _{GS} = 10V	-	50	-	
Rise time	t _r *6	I _D = 7.5A		50	-	20
Turn - off delay time	t _{d(off)} *6	R _L ≃ 40Ω		150	300	ns
Fall time	t _f *6	R _G = 10Ω		60	120	

• Gate charge characteristics (T_a = 25°C

Parameter Symbol Conditions		Values		
Parameter Symbol Conditions	Min.	Тур.	Max.	Unit
Total gate charge Q_g^{*6} $V_{DD} \simeq 300V$	-	50	-	
Gate - Source charge Q_{gs}^{*6} $I_D = 15A$	-	8	-	nC
Gate - Drain charge Q _{gd} *6 V _{GS} = 10V	-	20	-	
Gate plateau voltage $V_{(plateau)}$ $V_{DD} \simeq 300$ V, $I_D = 15$ A	-	6	-	V

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C

- *4 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C, f = 10kHz
- *5 Reference measurement circuits Fig.5-1.

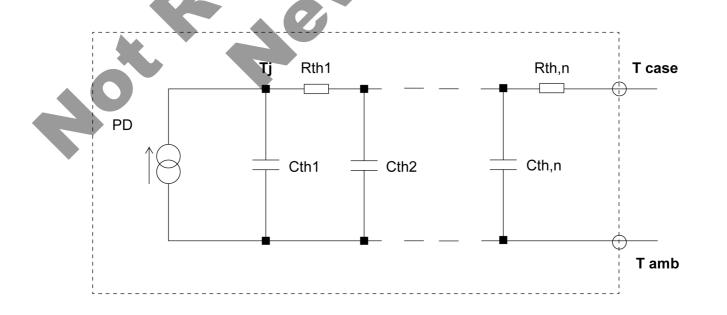
*6 Pulsed

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Currence of	Canditiana	Values			- Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _S *1	T - 25°0	-	-	15	А
Pulse forward current	ا _{SP} *2	T _C = 25℃ -	-	-	60	A
Forward voltage	V_{SD}^{*6}	V _{GS} = 0V, I _S = 15A	-	-	1.5	V
Reverse recovery time	t _{rr} *6		-	482	-	ns
Reverse recovery charge	Q _{rr} *6	I _S = 15A di/dt = 100A/µs		6.3	-	μC
Peak reverse recovery current	^{*6}			26	-	А
Peak rate of fall of reverse recovery current	di _{rr} /dt	T _j = 25°C	5	700	-	A/µs

• Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.117		C _{th1}	0.00318	
R _{th2}	0.662	K/W	C _{th2}	0.0429	Ws/K
R _{th3}	2.14		C _{th3}	0.507	







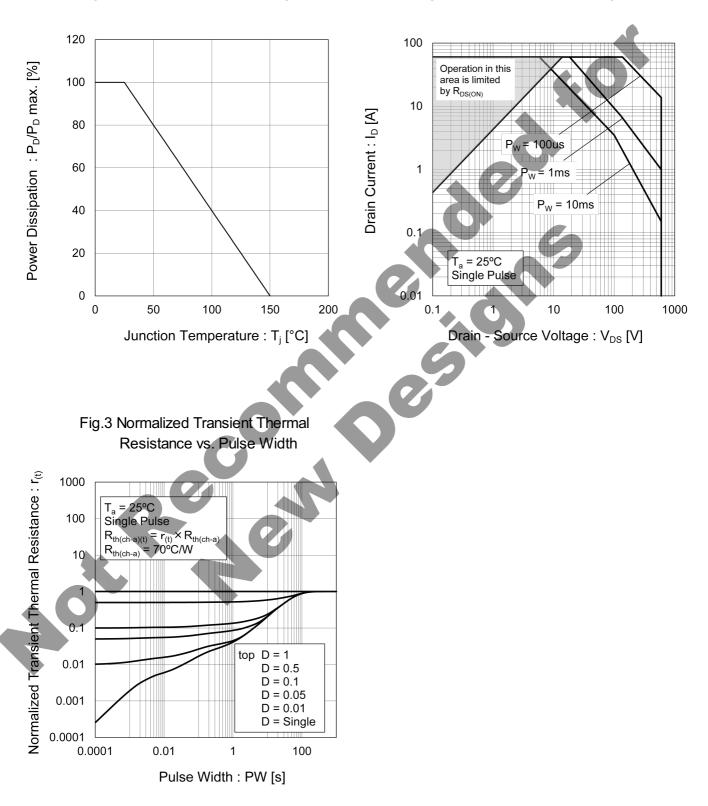


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



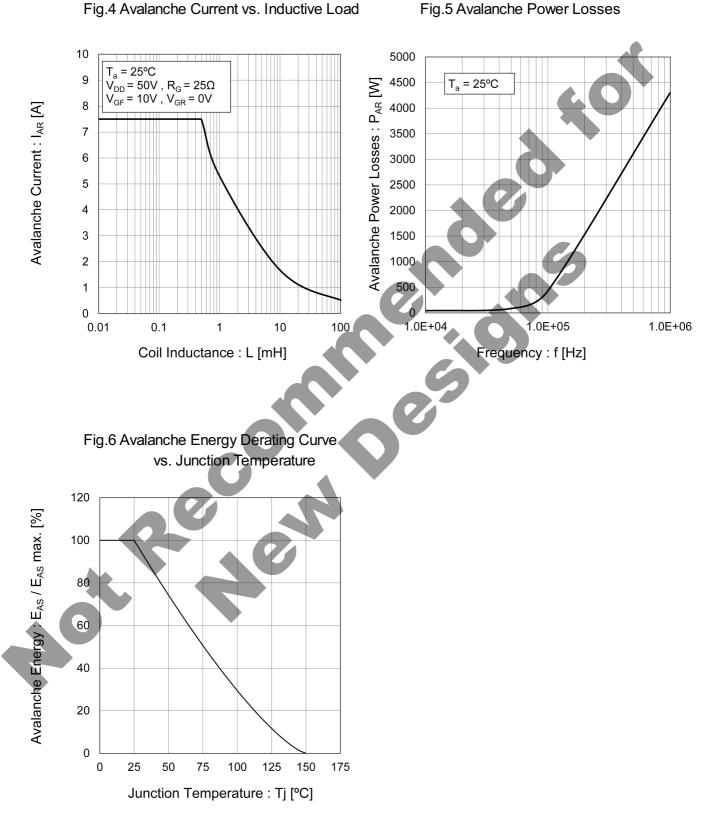


Fig.5 Avalanche Power Losses



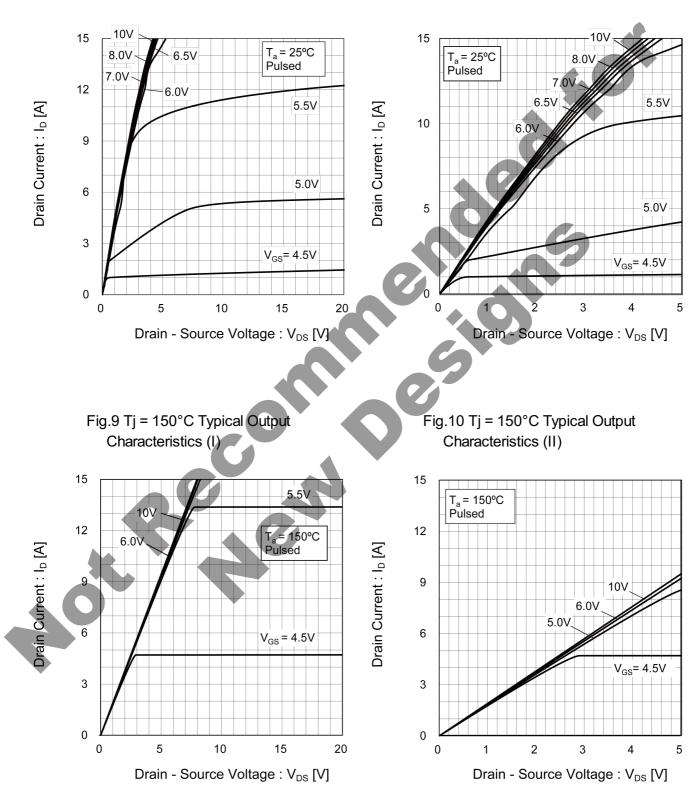
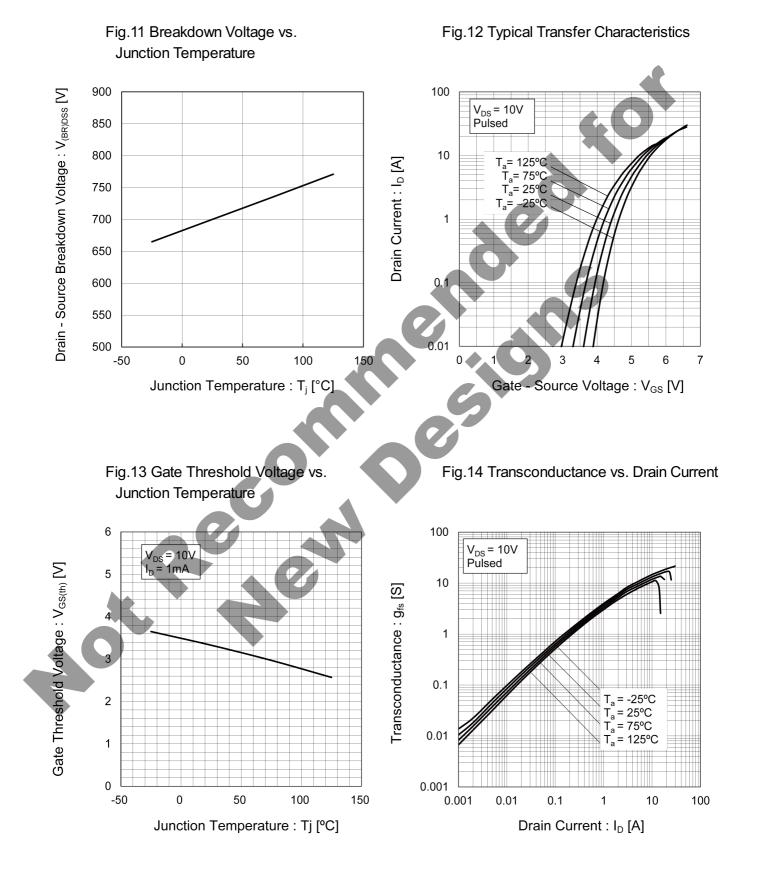


Fig.7 Typical Output Characteristics(I)

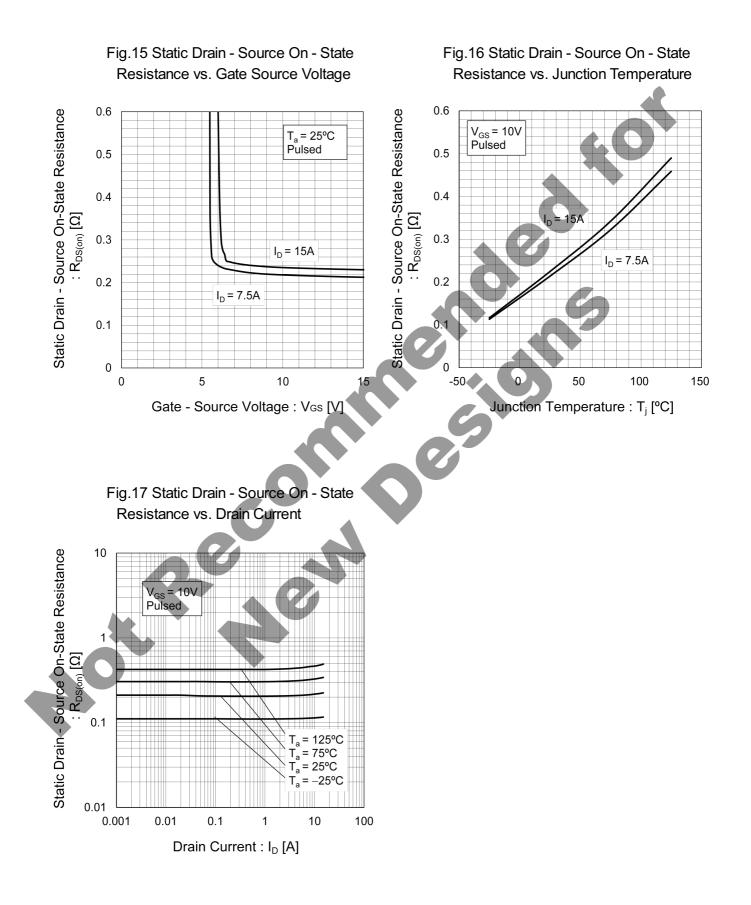
Fig.8 Typical Output Characteristics(II)





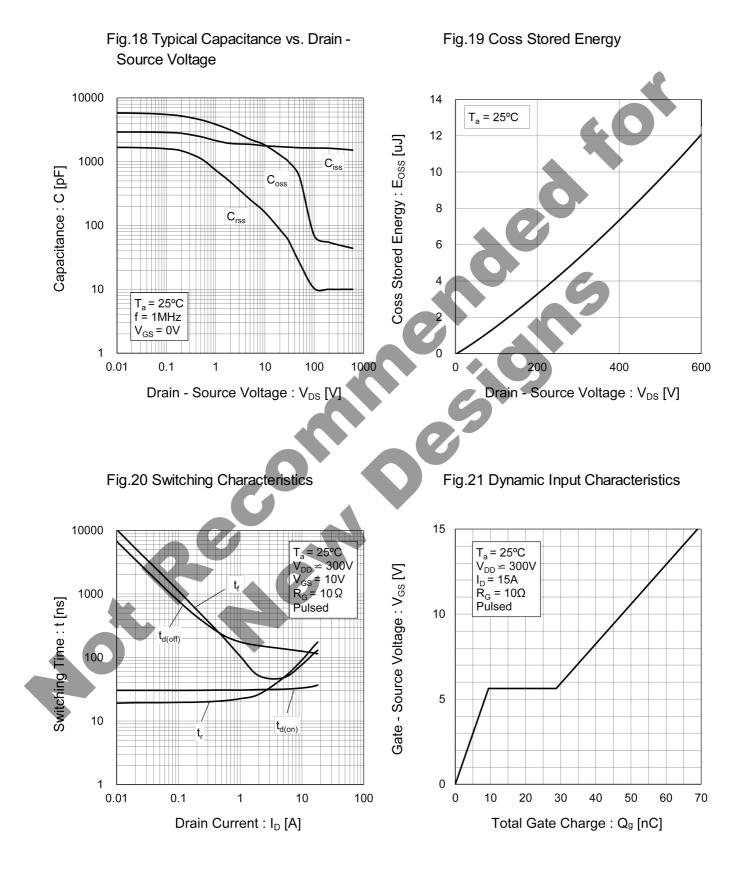




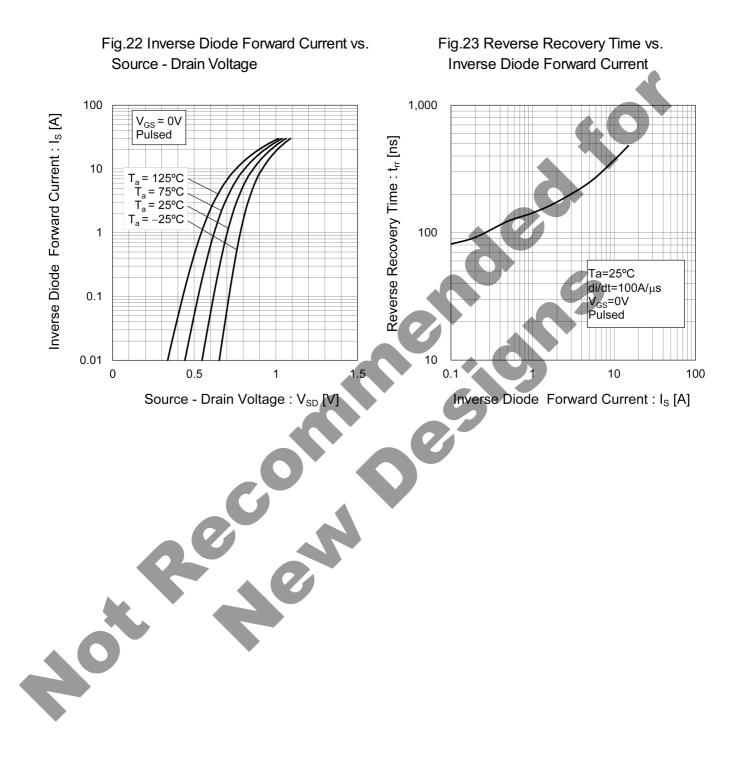












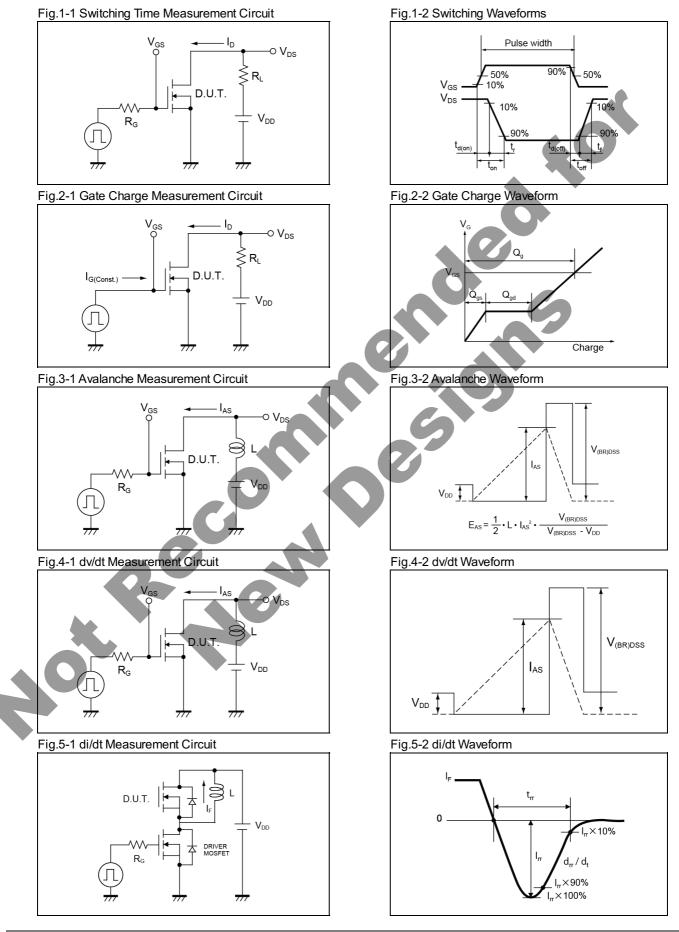




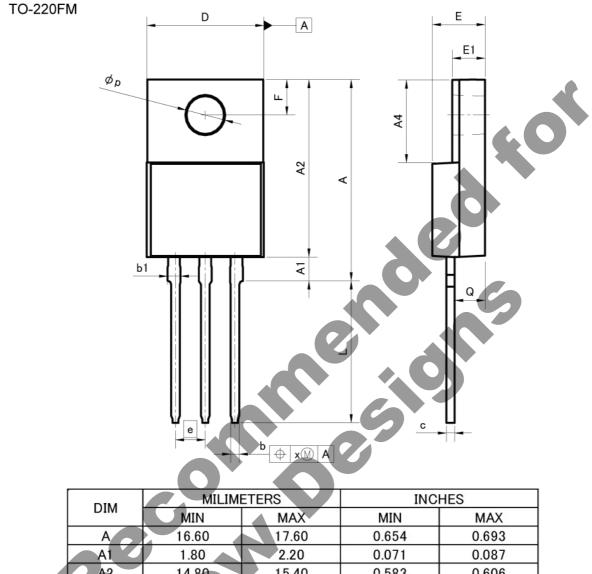
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Measurement circuits



Dimensions





A2	14.80	15.40	0.583	0.606	
A4	6.80	7.20	0.268	0.283	
b	0.70	0.90	0.028	0.035	
b1	1.10	1.50	0.043	0.059	
с	0.70	0.85	0.028	0.033	
D	9.90	10.30	0.390	0.406	
E	4.40	4.80	0.173	0.189	
e 2.		54	0.100		
E1	2.70	3.00	0.106	0.118	
F	2.80	3.20	0.110	0.126	
L	11.50	12.50	0.453	0.492	
р	3.00	3.40	0.118	0.134	
Q	2.10	3.10	0.083	0.122	
х	_	0.38		0.015	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications						
	JAPAN	USA	EU	CHINA		

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CLASSI

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CLASS III

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.

CLASS III

- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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